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Results of Search in AppFT Database for:

AANM/"Semprius Inc": 30 applications.

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PUB. APP. NO.	Title
1	20170179356 OPTICAL SYSTEMS FABRICATED BY PRINTING-BASED ASSEMBLY
2	20170179100 OPTICAL SYSTEMS FABRICATED BY PRINTING-BASED ASSEMBLY
3	20170179085 OPTICAL SYSTEMS FABRICATED BY PRINTING-BASED ASSEMBLY
4	20170133412 METHODS OF FORMING PRINTABLE INTEGRATED CIRCUIT DEVICES AND DEVICES FORMED THEREBY
5	20170133250 PRINTING TRANSFERABLE COMPONENTS USING MICROSTRUCTURED ELASTOMERIC SURFACES WITH PRESSURE MODULATED REVERSIBLE ADHESION
6	20170133248 PRINTING TRANSFERABLE COMPONENTS USING MICROSTRUCTURED ELASTOMERIC SURFACES WITH PRESSURE MODULATED REVERSIBLE ADHESION
7	20170098729 WAFER-INTEGRATED, ULTRA-LOW PROFILE CONCENTRATED PHOTOVOLTAICS (CPV) FOR SPACE APPLICATIONS
8	20170093501 MINIATURIZED DEVICES FOR COMBINED OPTICAL POWER CONVERSION AND DATA TRANSMISSION
9	20170093228 LAYERS OF SAFETY & FAILSAFE CAPABILITY FOR OPERATION OF CLASS IV LASER IN CONSUMER ELECTRONICS DEVICES
10	20170018675 MULTI-JUNCTION PHOTOVOLTAIC MICRO-CELL ARCHITECTURES FOR ENERGY HARVESTING AND/OR LASER POWER CONVERSION
11	20160190091 LASER ASSISTED TRANSFER WELDING PROCESS
12	20160072027 OPTICAL SYSTEMS FABRICATED BY PRINTING-BASED ASSEMBLY
13	20160056223 High-Yield Fabrication of Large-Format Substrates with Distributed, Independent Control Elements
14	20150380619 STRUCTURES AND METHODS FOR TESTING PRINTABLE INTEGRATED CIRCUITS
15	20150380436 METHODS OF FORMING PRINTABLE INTEGRATED CIRCUIT DEVICES AND DEVICES FORMED THEREBY
16	20150348926 METHODS FOR SURFACE ATTACHMENT OF FLIPPED ACTIVE COMPONENTS
17	20150327388 Electrically Bonded Arrays of Transfer Printed Active Components
18	20150207012 PRINTING-BASED ASSEMBLY OF MULTI-JUNCTION, MULTI-TERMINAL PHOTOVOLTAIC DEVICES AND RELATED METHODS
19	20150163906 Substrates with Transferable Chiplets

- 20 [20150135525](#) [METHODS FOR SURFACE ATTACHMENT OF FLIPPED ACTIVE COMPONENTS](#)
 - 21 [20150079783](#) [Methods of Forming Printable Integrated Circuit Devices and Devices Formed Thereby](#)
 - 22 [20140373898](#) [OPTICAL SYSTEMS FABRICATED BY PRINTING-BASED ASSEMBLY](#)
 - 23 [20140264937](#) [Through-Silicon Vias and Interposers Formed by Metal-Catalyzed Wet Etching](#)
 - 24 [20140264763](#) [ENGINEERED SUBSTRATES FOR SEMICONDUCTOR EPITAXY AND METHODS OF FABRICATING THE SAME](#)
 - 25 [20140261628](#) [HIGH EFFICIENCY SOLAR RECEIVERS INCLUDING STACKED SOLAR CELLS FOR CONCENTRATOR PHOTOVOLTAICS](#)
 - 26 [20140261627](#) [POWER AUGMENTATION IN CONCENTRATOR PHOTOVOLTAIC MODULES BY COLLECTION OF DIFFUSE LIGHT](#)
 - 27 [20140048128](#) [SURFACE MOUNTABLE SOLAR RECEIVER WITH INTEGRATED THROUGH SUBSTRATE INTERCONNECT AND OPTICAL ELEMENT CRADLE](#)
 - 28 [20140034127](#) [SURFACE-MOUNTABLE LENS CRADLES AND INTERCONNECTION STRUCTURES FOR CONCENTRATOR-TYPE PHOTOVOLTAIC DEVICES](#)
 - 29 [20130215929](#) [INDIRECT TEMPERATURE MEASUREMENTS OF DIRECT BANDGAP \(MULTIJUNCTION\) SOLAR CELLS USING WAVELENGTH SHIFTS OF SUB-JUNCTION LUMINESCENCE EMISSION PEAKS](#)
 - 30 [20130146120](#) [HIGH CONCENTRATION PHOTOVOLTAIC MODULES AND METHODS OF FABRICATING THE SAME](#)
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